10A SCHOTTKY BARRIER RECTIFIER

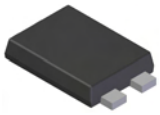
PowerDI®5

Features

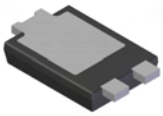
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- Very Low Leakage Current
- High Forward Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

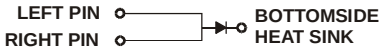
- Case: PowerDI®5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Polarity: See Diagram
- Weight: 0.096 grams (approximate)



Top View



Bottom View



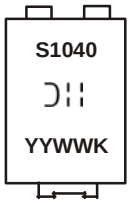
Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 2)

Part Number	Case	Packaging
PDS1040-13	Power DI®5	5000/Tape & Reel

Notes: 1. EU Directive **2002/95/EC** (RoHS). All applicable RoHS exemptions applied, see *EU Directive **2002/95/EC** Annex Notes.*
2. For packaging details, go to our website at http://www.diodes.com.

Marking Information



S1040 = Product type marking code
= Manufacturers' code marking
YYWW = Date code marking
YY = Last two digits of year (ex: 04 for 2004)
WW = Week code (01 - 53)
K = Factory designator

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Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	40	V
RMS Reverse Voltage	$V_{R(RMS)}$	28	V
Average Rectified Output Current (see also Figure 5)	I_O	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	275	A

Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{\theta JS}$	—	1.5	°C/W
Thermal Resistance Junction to Ambient Air (Note 3)	$R_{\theta JA}$	95	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 4)	$R_{\theta JA}$	75	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	50	—	°C/W
Operating Junction Temperature Range $V_R \le 80\% V_{RRM}$ $V_R \le 50\% V_{RRM}$	T_J	-65 to +150 -65 to +180		°C
Storage Temperature Range	T_{STG}	-65 to +150		°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	40	—	—	V	I_R = 1mA
Forward Voltage	V_F	— — — —	0.45 0.47 — 0.42	0.49 0.51 0.41 0.49	V	I_F = 8A, T_S = 25°C I_F = 10A, T_S = 25°C I_F = 8A, T_S = 125°C I_F = 10A, T_S = 125°C
Reverse Leakage Current (Note 6)	I_R	— — — —	0.02 5.5 0.03 6.5	0.3 25 0.7 50	mA	T_S = 25°C, V_R = 35V T_S = 100°C, V_R = 35V T_S = 25°C, V_R = 40V T_S = 100°C, V_R = 40V

Notes:
3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
4. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
5. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
6. Short duration pulse test used to minimize self-heating effect.
7. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 3.0mm.
8. Devices mounted such that RθJA = 19°C/W.

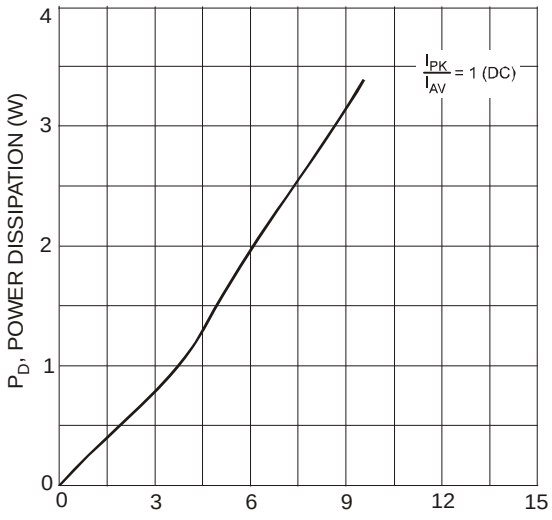

Fig. 1 Forward Power Dissipation

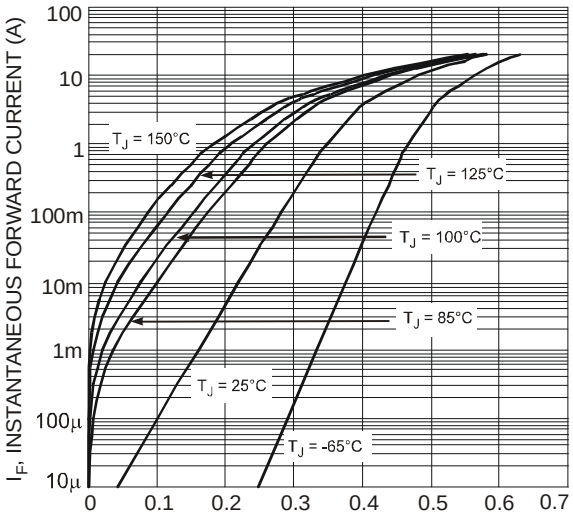

Fig. 2 Typical Forward Characteristics

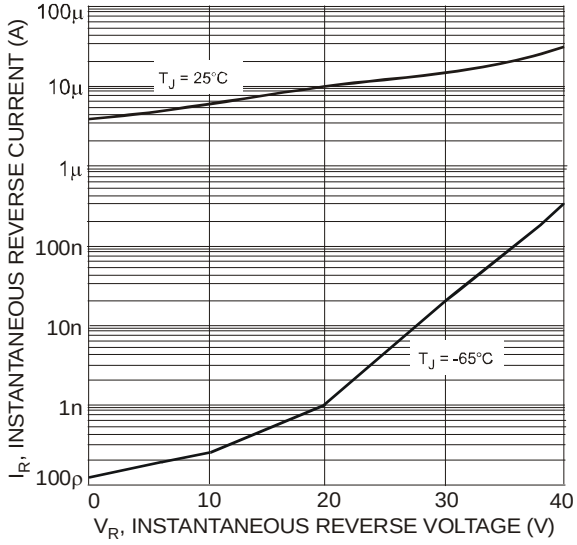

Fig. 3 Typical Reverse Characteristics

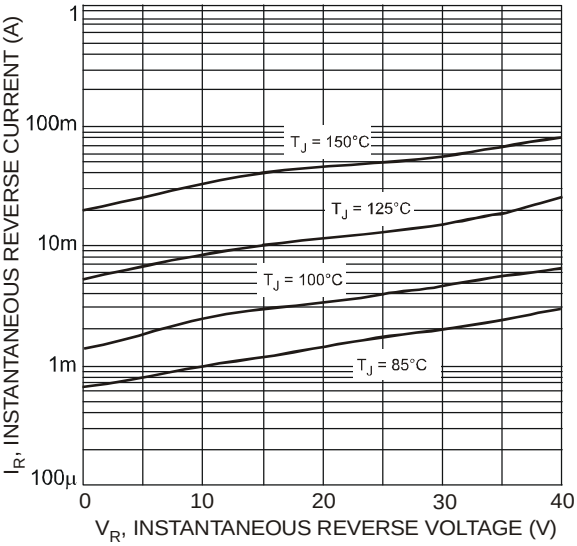

Fig. 4 Typical Reverse Characteristics

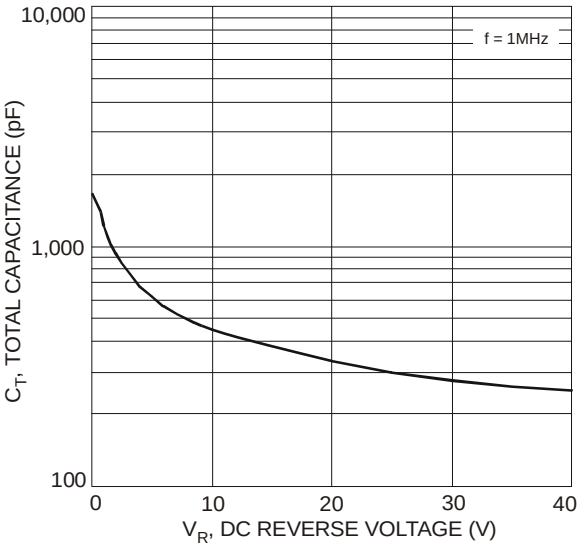

Fig. 5 Total Capacitance vs. Reverse Voltage

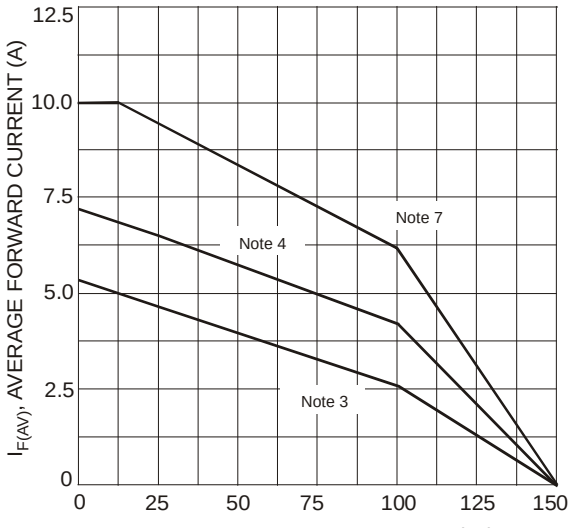

Fig. 6 Forward Current Derating Curve

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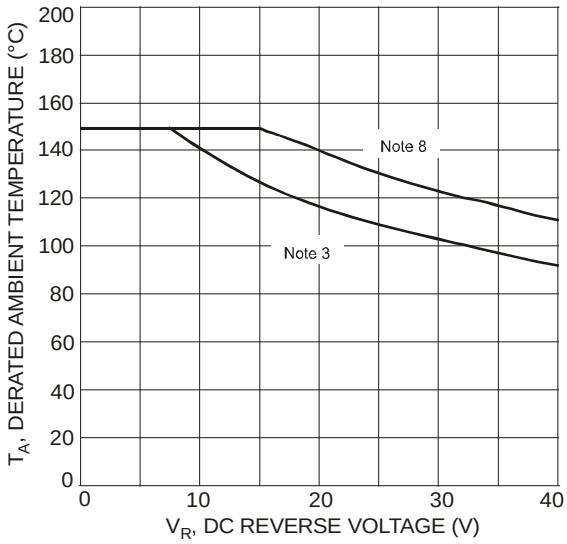
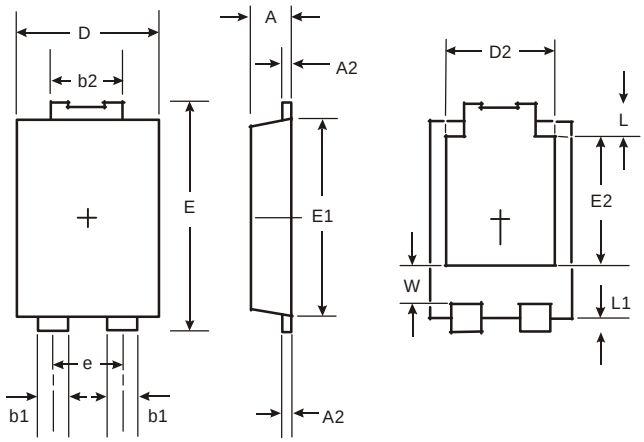


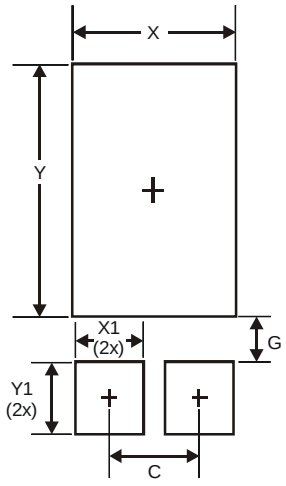
Fig. 7 Operating Temperature Derating

Package Outline Dimensions



PowerDI®5		
Dim	**Min**	**Max**
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.054 Typ	
E	6.40	6.60
e	1.84 Typ	
E1	5.30	5.45
E2	3.549 Typ	
L	0.75	0.95
L1	0.50	0.65
W	1.10	1.41
All Dimensions in mm		

Suggested Pad Layout



Dimensions	Value (in mm)
C	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400

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